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## FCP650N80Z

### N-Channel SuperFET® II MOSFET

800 V, 10 A, 650 mΩ

#### Features

- $R_{DS(on)} = 530 \text{ mΩ}$  (Typ.)
- Ultra Low Gate Charge (Typ.  $Q_g = 27 \text{ nC}$ )
- Low  $E_{oss}$  (Typ.  $2.8 \text{ uJ}$  @ 400V)
- Low Effective Output Capacitance (Typ.  $C_{oss(eff.)} = 124 \text{ pF}$ )
- 100% Avalanche Tested
- RoHS Compliant
- ESD Improved Capability

#### Applications

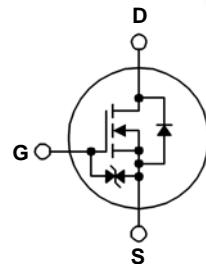
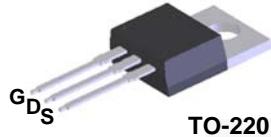
- AC - DC Power Supply
- LED Lighting

December 2015



#### Description

SuperFET® II MOSFET is Fairchild Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. In addition, internal gate-source ESD diode allows to withstand over 2kV HBM surge stress. Consequently, SuperFET II MOSFET is very suitable for the switching power applications such as Audio, Laptop adapter, Lighting, ATX power and industrial power applications.



**Absolute Maximum Ratings**  $T_C = 25^\circ\text{C}$  unless otherwise noted.

Symbol	Parameter		FCP650N80Z	Unit
$V_{DSS}$	Drain to Source Voltage		800	V
$V_{GSS}$	Gate to Source Voltage	- DC	$\pm 20$	V
		- AC ( $f > 1 \text{ Hz}$ )	$\pm 30$	
$I_D$	Drain Current	- Continuous ( $T_C = 25^\circ\text{C}$ )	10	A
		- Continuous ( $T_C = 100^\circ\text{C}$ )	6.3	
$I_{DM}$	Drain Current	- Pulsed	(Note 1) 24	A
$E_{AS}$	Single Pulsed Avalanche Energy		(Note 2) 204	mJ
$I_{AR}$	Avalanche Current		(Note 1) 1.6	A
$E_{AR}$	Repetitive Avalanche Energy		(Note 1) 1.62	mJ
$dv/dt$	MOSFET $dv/dt$		100	V/ns
	Peak Diode Recovery $dv/dt$	(Note 3)	20	
$P_D$	Power Dissipation	( $T_C = 25^\circ\text{C}$ )	162	W
		- Derate Above $25^\circ\text{C}$	1.30	
$T_J, T_{STG}$	Operating and Storage Temperature Range		-55 to +150	°C
$T_L$	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds		300	°C

#### Thermal Characteristics

Symbol	Parameter	FCP650N80Z	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.77	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	

## Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FCP650N80Z	FCP650N80Z	TO-220	Tube	N/A	N/A	50 units

## Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted.

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
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### Off Characteristics

$\text{BV}_{\text{DSS}}$	Drain to Source Breakdown Voltage	$V_{\text{GS}} = 0 \text{ V}$ , $I_D = 1 \text{ mA}$ , $T_J = 25^\circ\text{C}$	800	-	-	V
$\Delta \text{BV}_{\text{DSS}} / \Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = 1 \text{ mA}$ , Referenced to $25^\circ\text{C}$	-	0.8	-	$^\circ\text{C}$
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{\text{DS}} = 800 \text{ V}$ , $V_{\text{GS}} = 0 \text{ V}$	-	-	25	$\mu\text{A}$
		$V_{\text{DS}} = 640 \text{ V}$ , $V_{\text{GS}} = 0 \text{ V}$ , $T_C = 125^\circ\text{C}$	-	-	250	
$I_{\text{GSS}}$	Gate to Body Leakage Current	$V_{\text{GS}} = \pm 20 \text{ V}$ , $V_{\text{DS}} = 0 \text{ V}$	-	-	$\pm 10$	$\mu\text{A}$

### On Characteristics

$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{GS}} = V_{\text{DS}}$ , $I_D = 0.8 \text{ mA}$	2.5	-	4.5	V
$R_{\text{DS(on)}}$	Static Drain to Source On Resistance	$V_{\text{GS}} = 10 \text{ V}$ , $I_D = 4 \text{ A}$	-	530	650	$\text{m}\Omega$
$g_{\text{FS}}$	Forward Transconductance	$V_{\text{DS}} = 20 \text{ V}$ , $I_D = 4 \text{ A}$	-	7.8	-	S

### Dynamic Characteristics

$C_{\text{iss}}$	Input Capacitance	$V_{\text{DS}} = 100 \text{ V}$ , $V_{\text{GS}} = 0 \text{ V}$ , $f = 1 \text{ MHz}$	-	1178	1565	pF
$C_{\text{oss}}$	Output Capacitance		-	36	48	pF
$C_{\text{rss}}$	Reverse Transfer Capacitance		-	0.84	-	pF
$C_{\text{oss}}$	Output Capacitance	$V_{\text{DS}} = 480 \text{ V}$ , $V_{\text{GS}} = 0 \text{ V}$ , $f = 1 \text{ MHz}$	-	18	-	pF
$C_{\text{oss (eff.)}}$	Effective Output Capacitance	$V_{\text{DS}} = 0 \text{ V}$ to $480 \text{ V}$ , $V_{\text{GS}} = 0 \text{ V}$	-	124	-	pF
$Q_{\text{g(tot)}}$	Total Gate Charge at 10V	$V_{\text{DS}} = 640 \text{ V}$ , $I_D = 8 \text{ A}$ , $V_{\text{GS}} = 10 \text{ V}$	-	27	35	nC
$Q_{\text{gs}}$	Gate to Source Gate Charge	(Note 4)	-	6	-	nC
$Q_{\text{gd}}$	Gate to Drain "Miller" Charge		-	11	-	nC
ESR	Equivalent Series Resistance	$f = 1 \text{ MHz}$	-	1.9	-	$\Omega$

### Switching Characteristics

$t_{\text{d(on)}}$	Turn-On Delay Time	$V_{\text{DD}} = 400 \text{ V}$ , $I_D = 8 \text{ A}$ , $V_{\text{GS}} = 10 \text{ V}$ , $R_g = 4.7 \Omega$	-	17	44	ns
$t_r$	Turn-On Rise Time		-	11	32	ns
$t_{\text{d(off)}}$	Turn-Off Delay Time		-	40	90	ns
$t_f$	Turn-Off Fall Time		-	3.4	17	ns

### Drain-Source Diode Characteristics

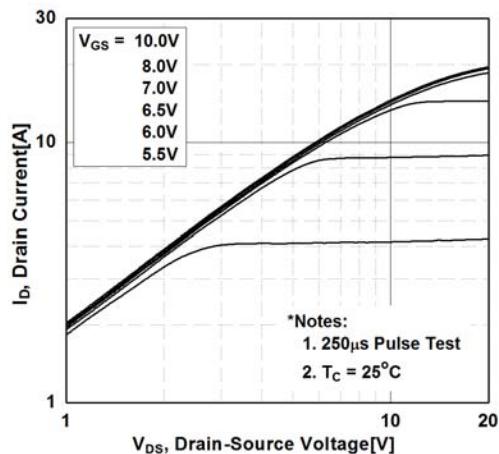
$I_S$	Maximum Continuous Drain to Source Diode Forward Current	-	-	10	A
$I_{\text{SM}}$	Maximum Pulsed Drain to Source Diode Forward Current	-	-	24	A
$V_{\text{SD}}$	Drain to Source Diode Forward Voltage	$V_{\text{GS}} = 0 \text{ V}$ , $I_{\text{SD}} = 8 \text{ A}$	-	-	1.2
$t_{\text{rr}}$	Reverse Recovery Time	$V_{\text{GS}} = 0 \text{ V}$ , $I_{\text{SD}} = 8 \text{ A}$ , $dI_F/dt = 100 \text{ A}/\mu\text{s}$	-	365	-
$Q_{\text{rr}}$	Reverse Recovery Charge		-	5.9	-

#### Notes:

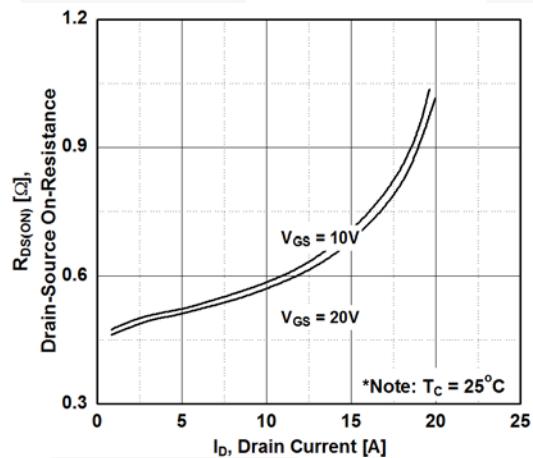
1. Repetitive rating: pulse width limited by maximum junction temperature.
2.  $I_{\text{AS}} = 1.6 \text{ A}$ ,  $R_G = 25 \Omega$ , Starting  $T_J = 25^\circ\text{C}$
3.  $I_{\text{SD}} \leq 10 \text{ A}$ ,  $dI/dt \leq 200 \text{ A}/\mu\text{s}$ ,  $V_{\text{DD}} \leq \text{BV}_{\text{DSS}}$ , Starting  $T_J = 25^\circ\text{C}$
4. Essentially independent of operating temperature typical characteristics.

## Typical Performance Characteristics

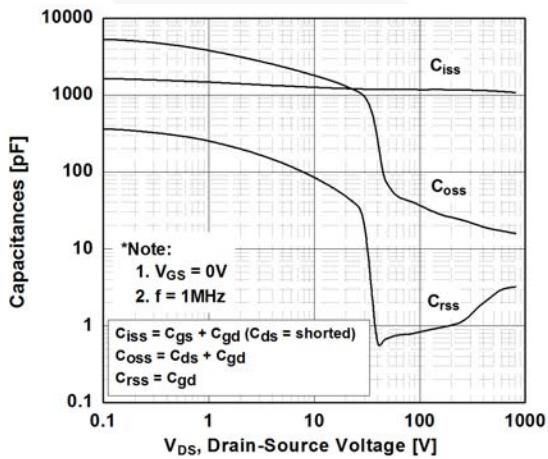
**Figure 1. On-Region Characteristics**



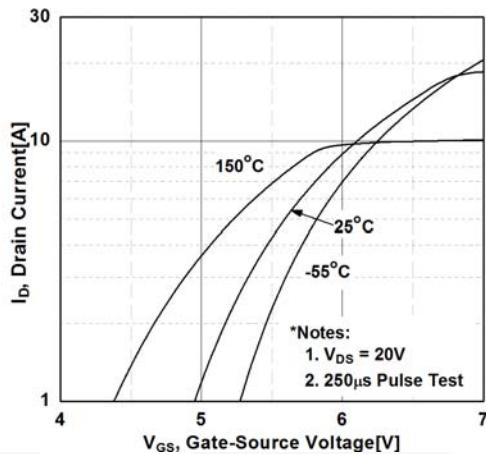
**Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage**



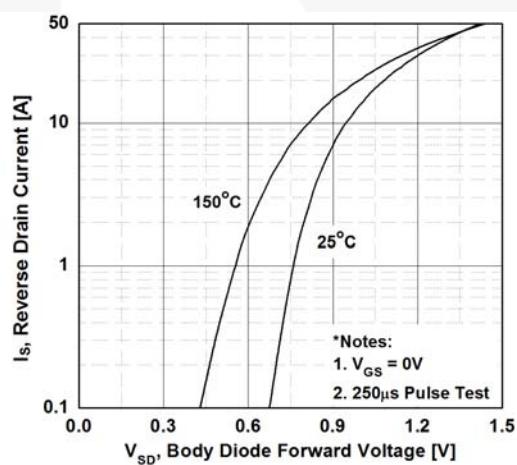
**Figure 5. Capacitance Characteristics**



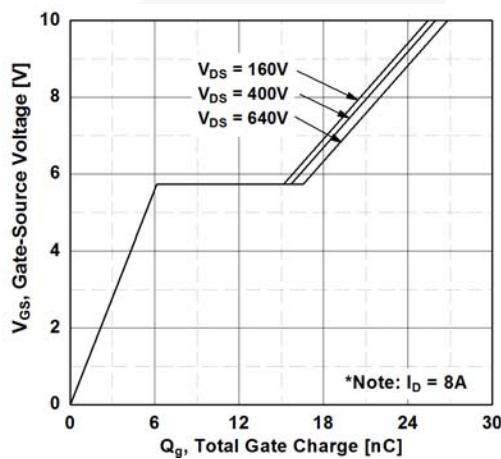
**Figure 2. Transfer Characteristics**



**Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature**

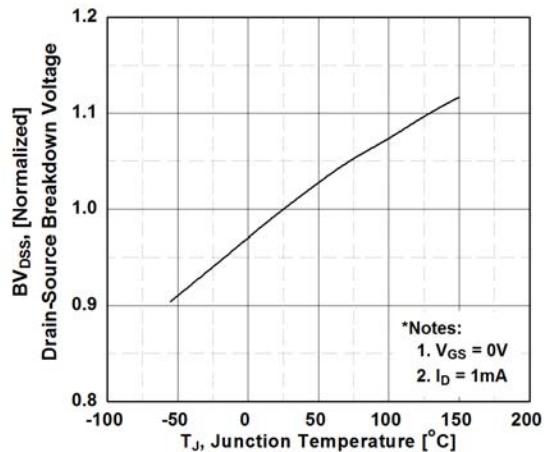


**Figure 6. Gate Charge Characteristics**

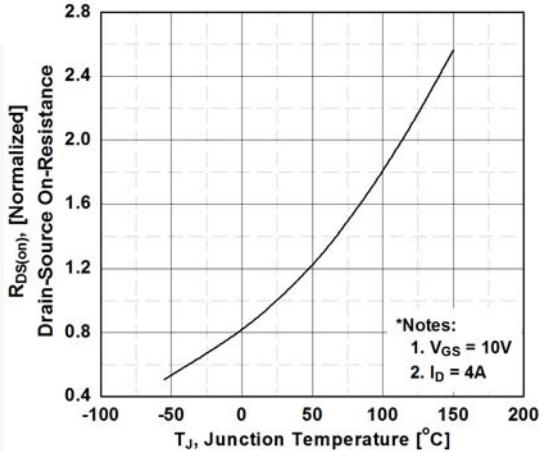


## Typical Performance Characteristics (Continued)

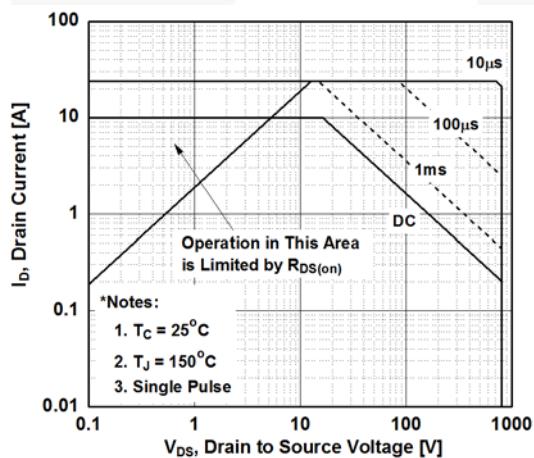
**Figure 7. Breakdown Voltage Variation vs. Temperature**



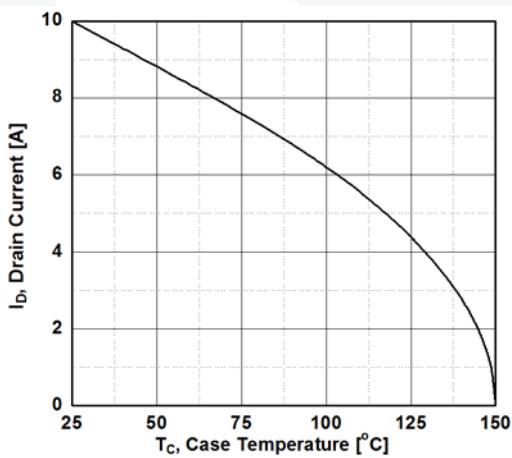
**Figure 8. On-Resistance Variation vs. Temperature**



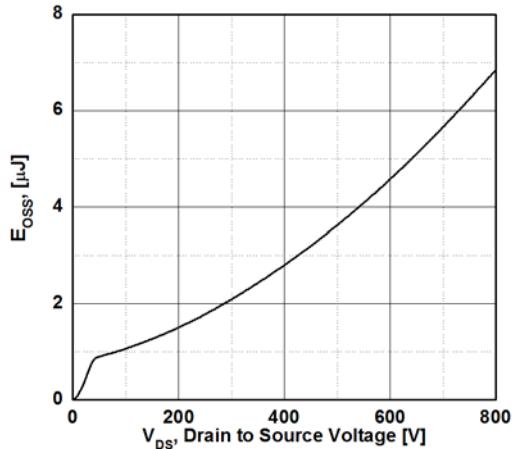
**Figure 9. Maximum Safe Operating Area**



**Figure 10. Maximum Drain Current vs. Case Temperature**

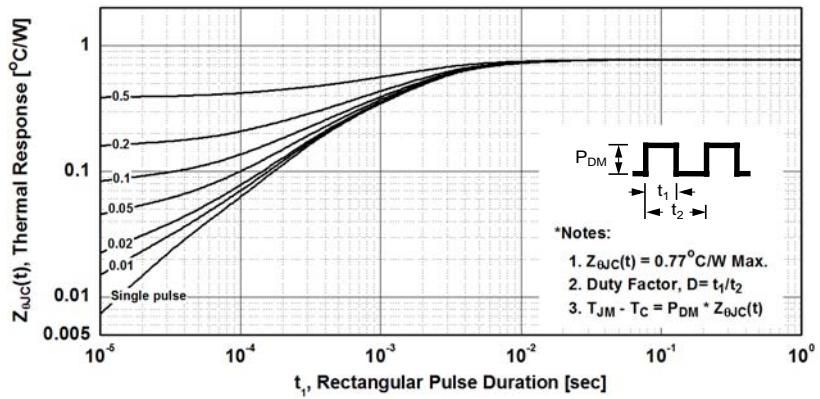


**Figure 11. Eoss vs. Drain to Source Voltage**



## Typical Performance Characteristics (Continued)

Figure 12. Transient Thermal Response Curve



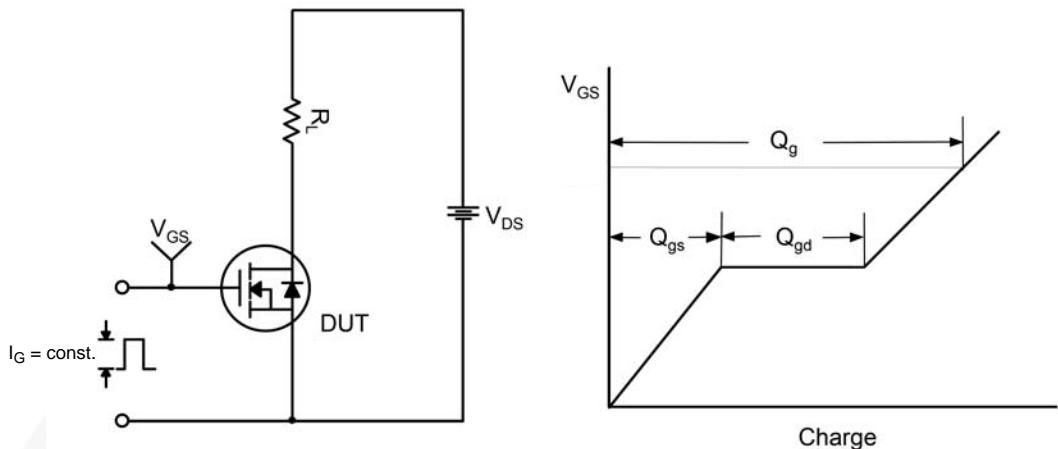


Figure 13. Gate Charge Test Circuit & Waveform

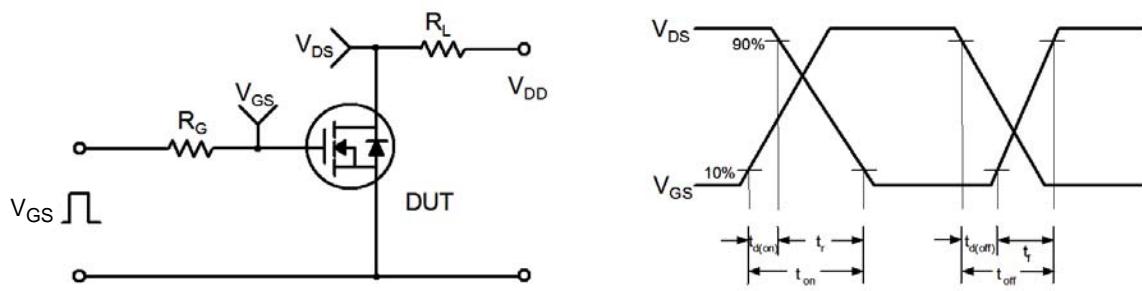


Figure 14. Resistive Switching Test Circuit & Waveforms

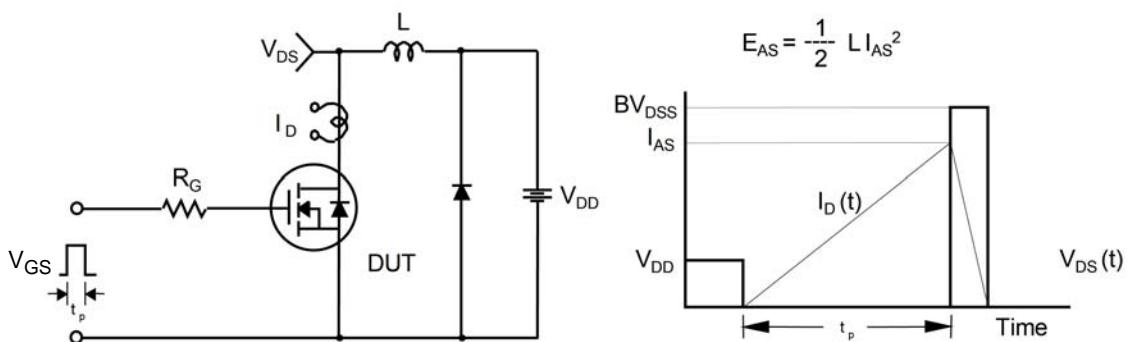


Figure 15. Unclamped Inductive Switching Test Circuit & Waveforms

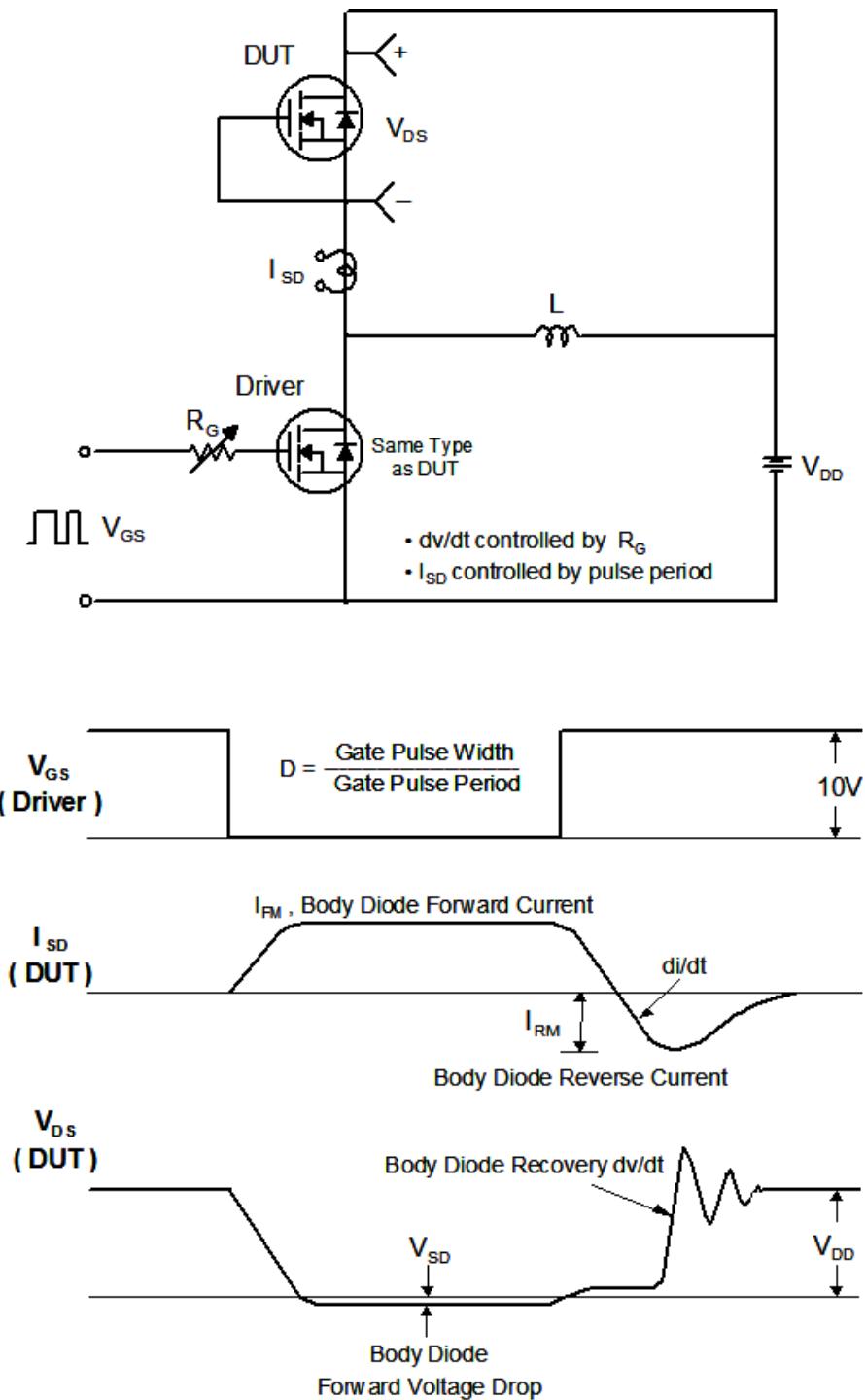
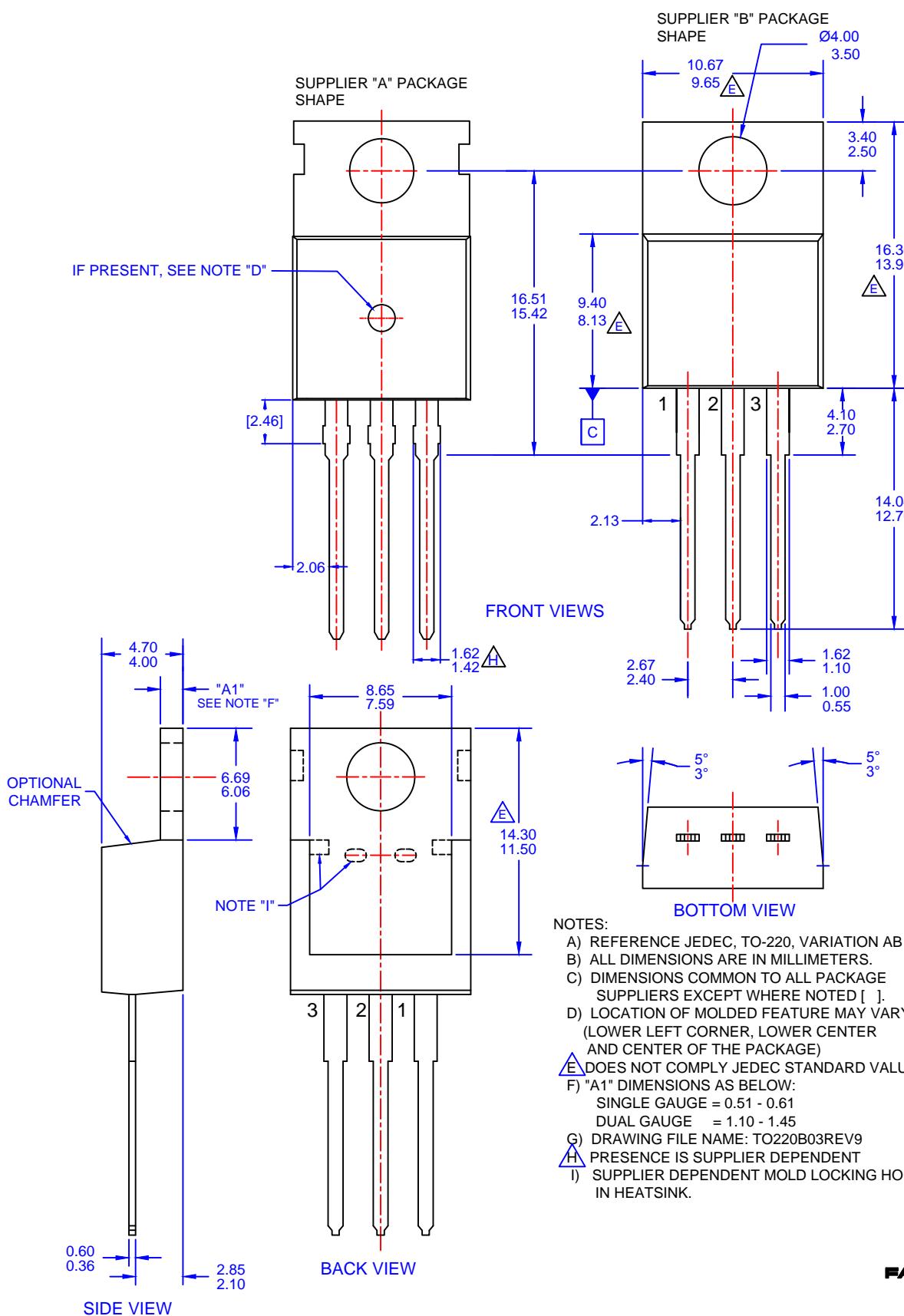


Figure 16. Peak Diode Recovery dv/dt Test Circuit &amp; Waveforms



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